

# MOS FIELD EFFECT TRANSISTOR

**2SJ448** 

## SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The 2SJ448 is P-Channel MOS Field Effect Transistor designed for high voltage switching applications.

### **FEATURES**

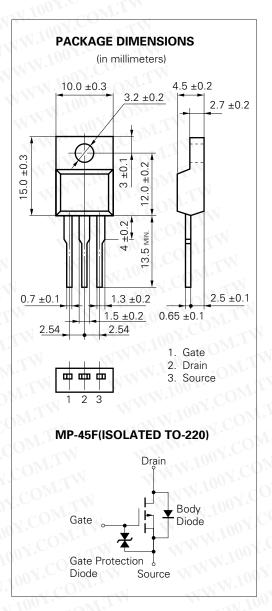
- Low On-Resistance
  - RDS(on) = 2.0  $\Omega$  MAX. (@ VGS = -10 V, ID = -2.0 A)
- Low Ciss Ciss = 470 pF TYP.
- Built-in G-S Gate Protection Diodes
- High Avalanche Capability Ratings
- Isolated TO-220 Package

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	-250	V
Gate to Source Voltage	Vgss	∓25	٧
Drain Current (DC)	ID(DC)	∓4.0	Α
Drain Current (pulse)*	ID(pulse)	∓16	Α
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	30	W
Total Power Dissipation (TA = 25 $^{\circ}$ C)	PT2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current**	las	-4.0	Α
Single Avalanche Energy**	Eas	80	mJ

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = -20 V  $\rightarrow$  0

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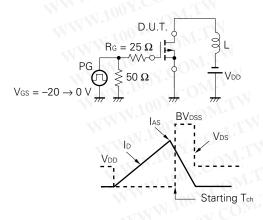


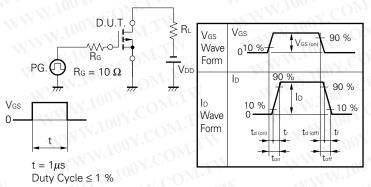
## **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)	N	1.5	2.0	Ω	Vgs = -10 V, ID = -20 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	-4.0	-4.8	-5.5	V	$V_{DS} = -10 \text{ V}, \text{ ID} = -1 \text{ mA}$
Forward Transfer Admittance	l yfs l	1.0	2.3	W.	S	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -20 A
Drain Leakage Current	loss	W	4	-100	μΑ	V <sub>DS</sub> = −250 V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss	W		∓10	μΑ	V <sub>GS</sub> = ∓25 V, V <sub>DS</sub> = 0
Input Capacitance	Ciss	M	470	WW	pF	V <sub>DS</sub> = −10 V
Output Capacitance	Coss	DM.	200		pF	V <sub>GS</sub> = 0
Reverse Transfer Capacitance	Crss	OM.I	70		pF	f = 1 MHz
Turn-On Delay Time	td(on)	COM	13		ns	ID = -2.0 A
Rise Time	tr 100	MOD	7		ns	$V_{GS(on)} = -10 \text{ V}$
Turn-Off Delay Time	td(off)	Y.CO	34		ns	V <sub>DD</sub> = −125 V
Fall Time	tf	M.Co.	10		ns	$R_G = 10 \Omega$
Total Gate Charge	Qg	10 Y.CC	15	N	nC	I <sub>D</sub> = -4.0 A
Gate to Source Charge	Qgs	ONY.C	4	W	nC	V <sub>DD</sub> = -200 V
Gate to Drain Charge	QgD	In.	9	TW	nC	V <sub>GS</sub> = −10 V
Body Diode Forward Voltage	V <sub>F</sub> (S-D)	100	1.0		V	IF = -4.0 A, VGS = 0
Reverse Recovery Time	trr	W.100	195	1.1	ns	IF = -4.0 A, VGS = 0
Reverse Recovery Charge	Qrr	TW.100	760	$M_{TL}$	nC	di/dt = 50 A/μs

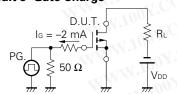
## **Test Circuit 1 Avalanche Capability**

# Test Circuit 2 Switching Time





## **Test Circuit 3 Gate Charge**

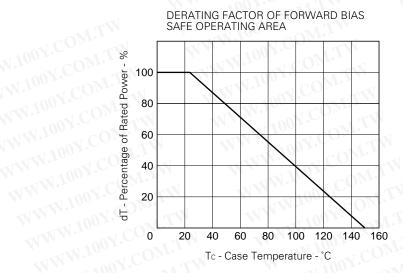


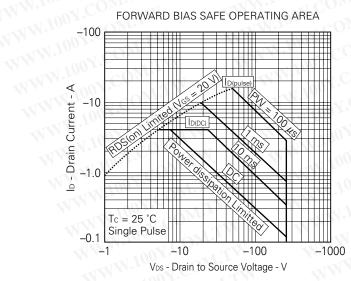
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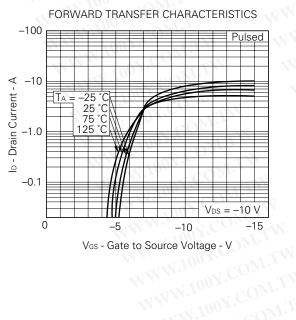
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

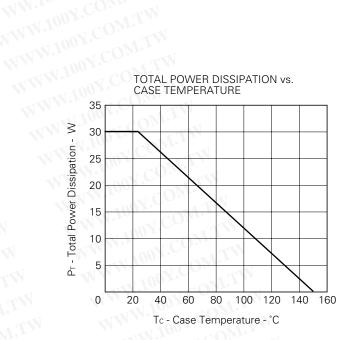


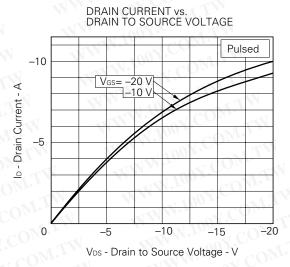
## TYPICAL CHARACTERISTICS (TA = 25 °C)





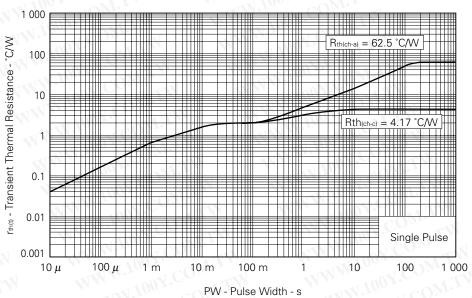




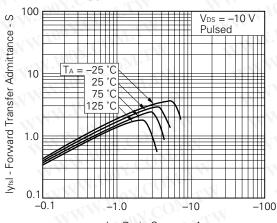


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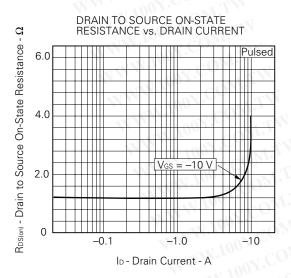
## TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



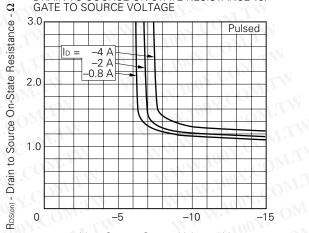




## ID - Drain Current - A

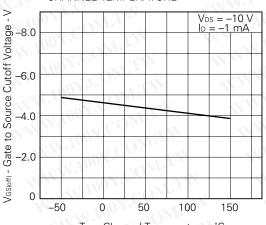


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



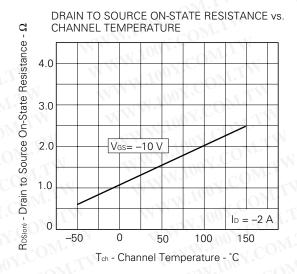
V<sub>GS</sub> - Gate to Source Voltage - V

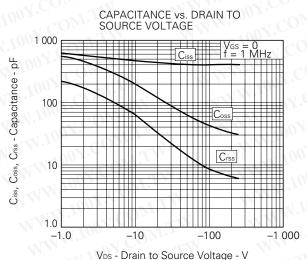
#### GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

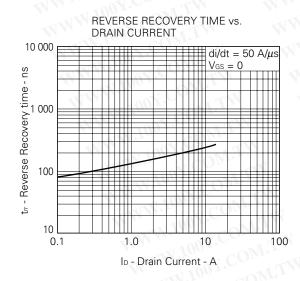


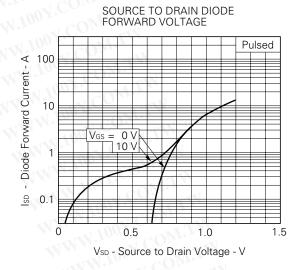
Tch - Channel Temperature - °C

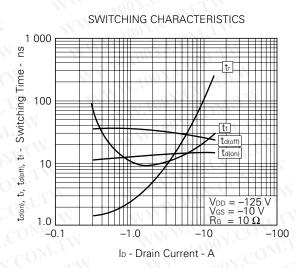
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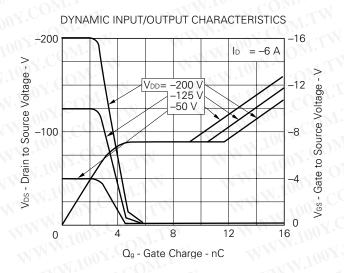








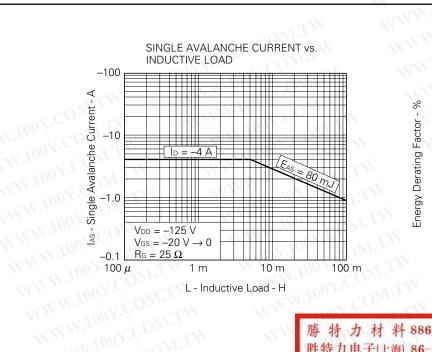


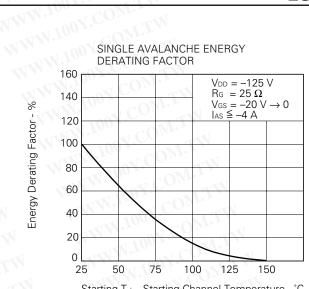


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Starting Tch - Starting Channel Temperature - °C

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#### **REFERENCE**

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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MMM.1001. 29. WWW.100Y.C The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the WWW.100Y.C rated voltage may be applied to this device. WWW.100 WWW.100Y.COM.

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